

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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				REVISIONS						
				REV	ECO		SCRIPTION	DATE	BY	APPR
				B1	-	RELEAS	ED DRAWING	JAN-18-2014	ARROW	TOMMY
NOTES: (UNLESS 1. MATERIAL: 1.1 CONTACT I 1.2 OUTER SPR 2. SPECIFICATION 2.1 CURRENT F 2.2 TERMINATI 2.3 WIRE RANC 2.4 WIRE INSU 3. ROHS COMPLI 4. ALL DIMENSIO 5. AVAILABLE TOC 5.1 HAND CRIM 5.2 CRIMP APP 5.3 EXTRACTIO	RATING: 13A MAX. ION TYPE: CRIMPING. GE: 16~18AWG. LATION DIA(MAX):Ø3.2mm. ANT. NS ARE FOR REFERENCE USE ONLY. OLS: MPER: MFX-3954. PLICATOR: MFX-3957. DN TOOL: QXRT16.	SECTION A-A SECTION B-B	16		Ø3.2 Ø3.2	Ø1.5		18		
P/N	CONTACT PLATING(MATING AREA)									
SP16M1T	TIN PLATING OVER NICKEL.		QUANTITY				DESCR ALS LIST			ITEM
SP16M1F	GOLD FLASH PLATING OVER NICKEL.		UNLESS OTHERWIS 1) All dimensions are i 2) Tolerances are as for	in metric(mm). ollows:	DRAWN:	ATURES DATE ARROW JAN-17-2014	An	nphe	nol	
SP16M1G10	10μ"GOLD PLATING OVER NICKEL.		3 PL DEC ±0.15	Fractions ±1/6- Angles ±1°	CHECKED: ENGINEER:		44724 Mor	stems - www.am	phenol-si	ne.com
SP16M1G15	15µ"GOLD PLATING OVER NICKEL.		MATERIAL SPECIFICATION	_	APPROVAL:			wnship, MI 48036 MATE,PIN CON	TACT	
SP16M1G30	30µ"GOLD PLATING OVER NICKEL.		PROCESS SPECIFICATION	NS:	THIS DRAWING	IS SUPPLIED FOR DNLY. DESIGN FEATURES, IS AND PERFORMANCE DATA		ED, 16-18AWG,		
			NEXT ASS'Y:		THE AMPHENO OF REPRODUC	IS AND PERFORMANCE DATA IN ARE THE PROPERTY OF L CORPORATION. NO RIGHTS TION ARE IMPLIED. ALL RE SUBJECT TO NORMAL NG VARIATIONS.	B C- SCALE: NONE	SP16M1X		B1 OF 1